Emitter common (dual digital transistors)

Datasheet

| Parameter            | DTr1 and DTr2 |
|----------------------|---------------|
| V <sub>CC</sub>      | 50V           |
| I <sub>C(MAX.)</sub> | 100mA         |
| R <sub>1</sub>       | 47kΩ          |
| R <sub>2</sub>       | 47kΩ          |

### Features

- 1)Two DTC144E chips in a EMT or UMT or SMT package.
- 2) Mounting cost and area can be cut in half.

### Outline

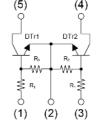
| SOT-553        | SOT-353         |
|----------------|-----------------|
| EMG2<br>(EMT5) | UMG2N<br>(UMT5) |
| SOT-25         |                 |
| FMG2A          |                 |

### •Inner circuit

### EMG2 / UMG2N

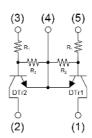
(SMT5)

- (1) DTr1 IN(Base)
- (2) DTr1 / DTr2 GND(Emitter)
- (3) DTr2 IN(Base)
- (4) DTr2 OUT(Collector)
- (5) DTr1 OUT(Collector)



### FMG2A

- (1) DTr1 OUT(Collector)
- (2) DTr2 OUT(Collector)
- (3) DTr2 IN(Base)
- (4) DTr1 / DTr2 GND(Emitter)
- (5) DTr1 IN(Base)



## Application

INVERTER, INTERFACE, DRIVER

### Packaging specifications

|          |                   |                 |                |                   |                 |                                 | ,       |
|----------|-------------------|-----------------|----------------|-------------------|-----------------|---------------------------------|---------|
| Part No. | Package           | Package<br>size | Taping<br>code | Reel size<br>(mm) | Tape width (mm) | Basic<br>ordering<br>unit.(pcs) | Marking |
| EMG2     | SOT-553<br>(EMT5) | 1616            | T2R            | 180               | 8               | 8000                            | G2      |
| UMG2N    | SOT-353<br>(UMT5) | 2021            | TR             | 180               | 8               | 3000                            | G2      |
| FMG2A    | SOT-25<br>(SMT5)  | 2928            | T148           | 180               | 8               | 3000                            | G2      |

# ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

<For DTr1 and DTr2 in common>

| P                            | Parameter |                     |             | Unit |
|------------------------------|-----------|---------------------|-------------|------|
| Supply voltage               |           |                     | 50          | V    |
| Input voltage                |           |                     | -10 to 40   | V    |
| Output current               |           |                     | 30          | mA   |
| Collector current            |           |                     | 100         | mA   |
|                              | EMG2      | P <sub>D</sub> *2*3 | 150         |      |
| Power dissipation            | UMG2N     | P <sub>D</sub> *2*3 | 150         | mW   |
| FMG2A                        |           |                     | 300         |      |
| Junction temperature         |           |                     | 150         | °C   |
| Range of storage temperature |           |                     | -55 to +150 | °C   |

# ● Electrical characteristics (T<sub>a</sub> = 25°C)

<For DTr1 and DTr2 in common>

| Devenue de v         | C: resh al                     | Conditions  | Values |      |      | Lloit |  |
|----------------------|--------------------------------|---|--------|------|------|-------|--|
| Parameter            | Symbol                         | Conditions  | Min.   | Тур. | Max. | Unit  |  |
| land the second      | $V_{I(off)}$                   | $V_{CC} = 5V, I_{O} = 100 \mu A$                            | -      | -    | 0.5  |       |  |
| Input voltage        | V <sub>I(on)</sub>             | $V_O = 0.3V$ , $I_O = 2mA$                                  | 3.0    | -    | -    | V     |  |
| Output voltage       | V <sub>O(on)</sub>             | I <sub>O</sub> = 10mA, I <sub>I</sub> = 0.5mA               | -      | 100  | 300  | mV    |  |
| Input current        | I <sub>I</sub>                 | V <sub>I</sub> = 5V   | -      | -    | 180  | μA    |  |
| Output current       | I <sub>O(off)</sub>            | V <sub>CC</sub> = 50V, V <sub>I</sub> = 0V                  | -      | -    | 500  | nA    |  |
| DC current gain      | G <sub>I</sub>                 | V <sub>O</sub> = 5V, I <sub>O</sub> = 5mA                   | 68     | -    | -    | -     |  |
| Input resistance     | R <sub>1</sub>                 | -   | 32.9   | 47   | 61.1 | kΩ    |  |
| Resistance ratio     | R <sub>2</sub> /R <sub>1</sub> | -   | 8.0    | 1.0  | 1.2  | -     |  |
| Transition frequency | f <sub>T</sub> *1              | V <sub>CE</sub> = 10V, I <sub>E</sub> = -5mA,<br>f = 100MHz | -      | 250  | -    | MHz   |  |

<sup>\*1</sup> Characteristics of built-in transistor



<sup>\*2</sup> Each terminal mounted on a reference land

<sup>\*3 120</sup>mW per element must not be exceeded.

<sup>\*4 200</sup>mW per element must not be exceeded.

## ● Electrical characteristic curves (T<sub>a</sub> = 25°C)

<For DTr1 and DTr2 in common>

Fig.1 Input Voltage vs. Output Current (ON Characteristics)

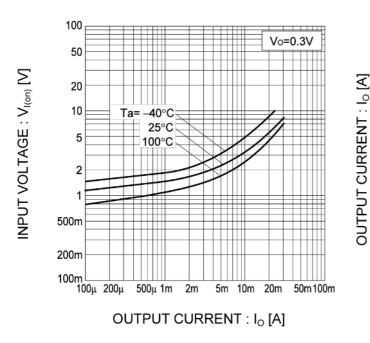
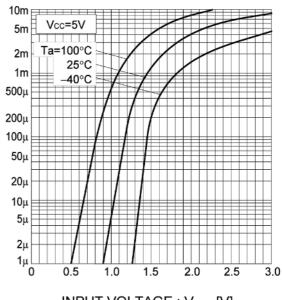


Fig.2 Output Current vs. Input Voltage (OFF Characteristics)



INPUT VOLTAGE :  $V_{I(off)}$  [V]

Fig.3 Output Current vs. Output Voltage

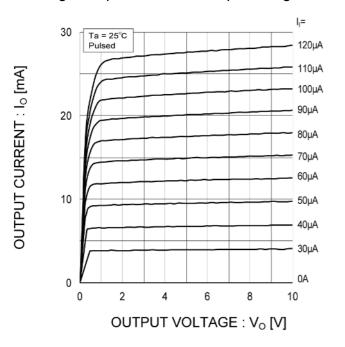
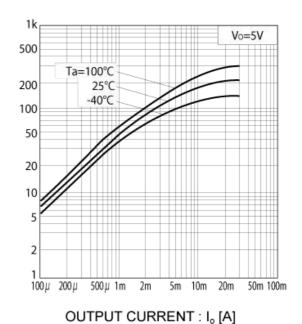


Fig.4 DC Current Gain vs. Output Current

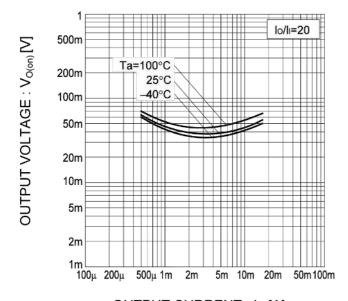


DC CURRENT GAIN : G

# ● Electrical characteristic curves (T<sub>a</sub> = 25°C)

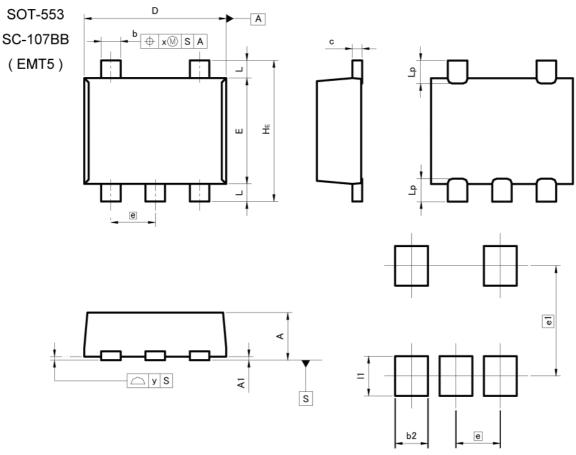
<For DTr1 and DTr2 in common>

Fig.5 Output Voltage vs. Output Current



OUTPUT CURRENT :  $I_0$  [A]

## Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

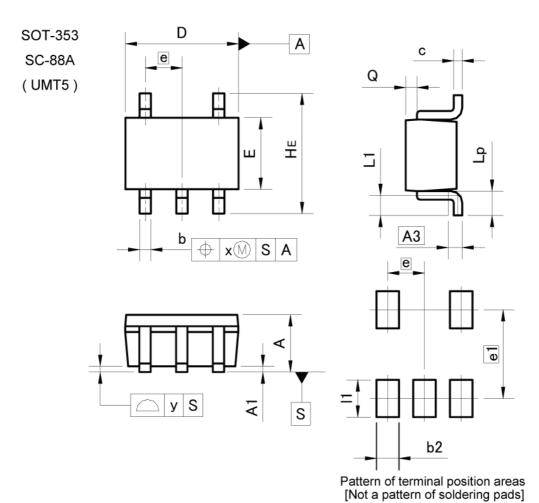
| DIM - | MILIM | ETERS | INC   | HES   |  |
|-------|-------|-------|-------|-------|--|
| DIM   | MIN   | MAX   | MIN   | MAX   |  |
| Α     | 0.45  | 0.55  | 0.018 | 0.022 |  |
| A1    | 0.00  | 0.10  | 0.000 | 0.004 |  |
| b     | 0.17  | 0.27  | 0.007 | 0.011 |  |
| С     | 0.08  | 0.18  | 0.003 | 0.007 |  |
| D     | 1.50  | 1.70  | 0.059 | 0.067 |  |
| E     | 1.10  | 1.30  | 0.043 | 0.051 |  |
| е     | 0.9   | 50    | 0.020 |       |  |
| HE    | 1.50  | 1.70  | 0.059 | 0.067 |  |
| L     | 0.10  | 0.30  | 0.004 | 0.012 |  |
| Lp    | -     | 0.35  | _     | 0.014 |  |
| x     | 2     | 0.10  | -     | 0.004 |  |
| у     |       | 0.10  | -     | 0.004 |  |

| DIM - | MILIM | ETERS | INCHES |       |
|-------|-------|-------|--------|-------|
| DIM L | MIN   | MAX   | MIN    | MAX   |
| b2    | =:    | 0.37  | _      | 0.015 |
| e1    | 1.25  |       | 0.0    | 049   |
| 11    | -     | 0.45  | -      | 0.018 |

Dimension in mm/inches



## Dimensions



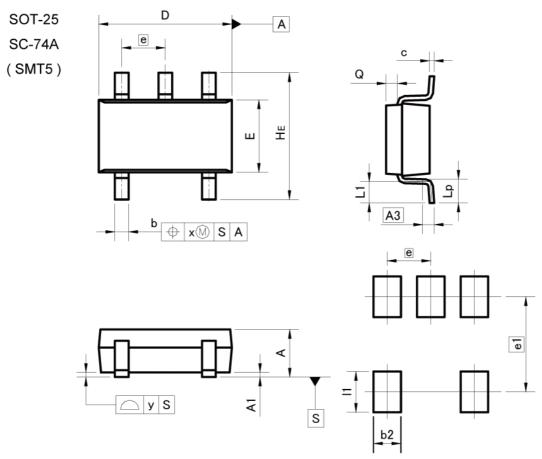
| DIM - | MILIM         | ETERS | INC              | HES   |
|-------|---------------|-------|------------------|-------|
| DIM [ | MIN           | MAX   | MIN              | MAX   |
| Α     | 0.80          | 1.00  | 0.031            | 0.039 |
| A1    | 0.00          | 0.10  | 0.000            | 0.004 |
| A3    | 0.3           | 25    | 0.0              | 10    |
| b     | 0.15          | 0.30  | 0.006            | 0.012 |
| С     | 0.10          | 0.20  | 0.004            | 0.008 |
| D     | 1.90          | 2.10  | 0.075            | 0.083 |
| E     | 1.15          | 1.35  | 0.045            | 0.053 |
| е     | 0.            | 65    | 0.0              | 26    |
| HE    | 2.00          | 2.20  | 0.079            | 0.087 |
| L1    | 0.20          | 0.50  | 0.008            | 0.020 |
| Lp    | 0.25          | 0.55  | 0.010            | 0.022 |
| Q     | 0.10          | 0.30  | 0.004            | 0.012 |
| х     |               | 0.10  | 15 <del>17</del> | 0.004 |
| У     | <del></del> 3 | 0.10  | 20-              | 0.004 |

| DIM | MILIMETERS     |      | INC           | HES   |
|-----|----------------|------|---------------|-------|
| DIM | MIN            | MAX  | MIN           | MAX   |
| b2  | <del>-</del> 2 | 0.40 | 8.            | 0.016 |
| e1  | 1.55           |      | 0.0           | 061   |
| 11  | T-1            | 0.65 | 0 <del></del> | 0.026 |

Dimension in mm/inches



## Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

| DIM | MILIM           | ETERS | INC   | HES   |
|-----|-----------------|-------|-------|-------|
| DIM | MIN             | MAX   | MIN   | MAX   |
| Α   | 1.00            | 1.30  | 0.039 | 0.051 |
| A1  | 0.00            | 0.10  | 0.000 | 0.004 |
| A3  | 0.:             | 25    | 0.0   | 10    |
| b   | 0.25            | 0.40  | 0.010 | 0.016 |
| С   | 0.09            | 0.25  | 0.004 | 0.010 |
| D   | 2.80            | 3.00  | 0.110 | 0.118 |
| E   | 1.50            | 1.80  | 0.059 | 0.071 |
| е   | 0.9             | 95    | 0.037 |       |
| HE  | 2.60            | 3.00  | 0.102 | 0.118 |
| L1  | 0.30            | 0.60  | 0.012 | 0.024 |
| Lp  | 0.40            | 0.70  | 0.016 | 0.028 |
| Q   | 0.20            | 0.30  | 0.008 | 0.012 |
| х   | <del>55</del> 6 | 0.20  | ₩.    | 0.008 |
| у   | 丽樹              | 0.10  | THE S | 0.004 |

| DIM | MILIM           | ETERS | INC            | HES   |
|-----|-----------------|-------|----------------|-------|
| DIM | MIN             | MAX   | MIN            | MAX   |
| b2  | <del>17</del> 8 | 0.60  | ₩.             | 0.024 |
| e1  | 2.10            |       | 0.0            | 083   |
| 11  | =:              | 0.90  | <del>5</del> 8 | 0.035 |

Dimension in mm/inches



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|---------|----------|----------|-----------|
| CLASSⅢ  | CL ACCTI | CLASSIIb | CI ΛΟΩ ΙΙ |
| CLASSIV | CLASSⅢ   | CLASSⅢ   | CLASSⅢ    |

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- 8. Confirm that operation temperature is within the specified range described in the product specification.
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  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
  may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
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